

# 2018 2nd International Conference on Materials Engineering and Applications (ICMEA 2019)

Da Nang, Vietnam

January 16-18, 2019

## Conference Introduction



2018 2nd International Conference on Materials Engineering and Applications (ICMEA 2019: <http://www.icmea.org/>) will be held in Da Nang, Vietnam during January 16-18, 2019.

It provides an opportunity for the delegates to meet, interact and exchange new ideas in the various areas of materials engineering and applications. ICMEA 2019 aims to proclaim knowledge and share new ideas amongst the professionals, industrialists and students from research areas of materials engineering and applications to share their research experiences and indulge in

interactive discussions and special sessions at the event.

## Good News

### 1. Publication

*Option One:* IOP Conference Series: **Materials Science and Engineering** (ISSN: 1757-899X), which can be indexed by **EI Compendex, Scopus** and so on.

For online and index information:  
<http://iopscience.iop.org/journal/1757-899X>

*Option Two:* **International Journal of Materials Science and Engineering** (IJMSE, ISSN: 2315-4527), which can be indexed by Ulrich's Periodicals Directory, Google Scholar, Crossref and so on.



### 2. Famous professors as Speakers

**Prof. Stephen John Pennycook**, National University of Singapore;

**Prof. Frank Otremba**, Federal Institute for Material Research and Testing, Germany;

**Prof. Takashige Omatsu**, Chiba University, Japan;

**Prof. Jae-Jin Shim**, Yeungnam University, South Korea;

**Prof. Tjokorda Gde Tirta Nindhia**, Udayana University, Indonesia.

### 3. Academic Visit

There will be a one-day visit in Da Nang on January 18, 2019.

## Important Dates

Paper Submission	November 05, 2018
Notification of Acceptance	November 25, 2018
Registration	December 15, 2018
Conference Dates	January 16-17, 2019
Academic Visit	January 18, 2019

## Call for Papers

Topics of interest for submission include, but are not limited to: **Materials Science and Engineering, Materials Processing Technology**---Metallic Alloys, Tool Materials, Superplastic Materials, Ceramics and Glasses, Composites, Amorphous Materials, Nanomaterials, Biomaterials, Multifunctional Materials, Smart Materials, Engineering Polymers, Functional materials, Nuclear fuel materials, Biomaterials, sensors and surfaces, Thin Film Chalcogenide Photovoltaic Materials, Nuclear Materials IV, Magnetic Materials, Multi Functional Magnetic Materials, Superconducting Materials, Structured Materials, Spintronics Materials and Devices, Hard/Soft Magnetic Materials; **Materials Properties, Measuring Methods and Applications**---Ductility, Crack Resistance, Fatigue, Creep-resistance, Fracture Mechanics, Mechanical Properties, Electrical Properties, and Magnetic Properties, Corrosion, Erosion, Wear Resistance, Non-Destructive Testing, Reliability Assessment, Toxicity, Working Properties of Materials and Products, Large Scale Applications, Electronics Applications; and Other related fields. (For more information, please visit <http://www.icmea.org/cfp.html>)

## Submission Methods

- Electronic Submission System:  
<http://confsys.iconf.org/submission/icmea2019>
- Conference Email Address: [icmea@cbees.net](mailto:icmea@cbees.net)

## Contact us

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